Sir:

Enclosed are:

Transmitted herewith for filing is the Patent Application of:

Anventor: HSIU-MEI YU, KEN-SHEN CHOU, HSIU-CHIEH CHENG, SHUN-LIANG HSU

For: ELASTOMER PLATING MASK SEALED WAFER LEVEL PACKAGE METHOD



$\begin{bmatrix} \mathbf{x} \end{bmatrix}$	<u> 3</u>	sheets	of	drawing(s)	-	formal.	
/							

An assignment of the invention to Taiwan Semiconductor Manufacturing Company

An associate power of attorney . Applicant claims small entity status

Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

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D D DEFOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE	><	><		\$ 740.
TOTAL CLAIMS	38 - 20=	18	x 18 =	\$ 324.
: =INDEP CLAIMS	3 -3=	0	x 84 =	\$ 0.
MULTIPLE	DEPENDENT CLA	IM PRESENTED	+ 260 =	
		S	SUB TOTAL	\$ 1,064.
		L.	ASSIGNMENT	\$40.
<u> </u>		يا	COTAL	\$ 1,104.

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I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Washington, D.C. 20231. Applicant

and/or Attorney requests the date of deposit as the Filing Date

Date of deposit

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NONPUBLICATION REQUEST UNDER 35 U.S.C. 122(b)(2)(B)(i) First Named Inventor HSiU-Hei YU

Title Elastomer Plating Mask Stated

Water Level Package Method

Atty Docket Number TSMD24

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

I hereby request that the attached application not be published under 35 U.S.C. 122(b):

1/3/02 Date

Signature

Staphen B. Ackerman Rost 37,76
Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).

Burden Hour Statement: This collection of information is required by 37 CFR 1.213(a). The information is used by the public to request that an application not be published under 36 U.S.C. 122(b) (and the PTO to process that request). Confidentially is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer. U.S. Patent and Trademark Office, Weshington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO. Assistant Commissioner for Patents, Washington, DC 20231.